

Applications

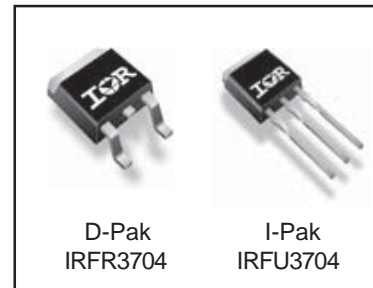
- High Frequency DC-DC Isolated Converters with Synchronous Rectification for Telecom and Industrial use
- High Frequency Buck Converters for Computer Processor Power
- 100% R_G Tested

HEXFET® Power MOSFET

V_{DSS}	R_{DS(on)} max	I_D
20V	9.5mΩ	75A

Benefits

- Ultra-Low R_{DS(on)}
- Very Low Gate Impedance
- Fully Characterized Avalanche Voltage and Current



Absolute Maximum Ratings

Symbol	Parameter	Max	Units
V _{DS}	Drain-Source Voltage	20	V
V _{GS}	Gate-Source Voltage	± 20	
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V	75 ④	A
I _D @ T _C = 70°C	Continuous Drain Current, V _{GS} @ 10V	63 ④	
I _{DM}	Pulsed Drain Current ①	300	
P _D @ T _C = 25°C	Maximum Power Dissipation ③	90	W
P _D @ T _A = 70°C	Maximum Power Dissipation ③	62	
	Linear Derating Factor	0.58	W/°C
T _J , T _{STG}	Junction and Storage Temperature Range	-55 to +175	°C

Thermal Resistance

Symbol	Parameter	Typ	Max	Units
R _{θJC}	Junction-to-Case ⑤	—	1.7	°C/W
R _{θJA}	Junction-to-Ambient (PCB Mount) *⑤	—	50	
R _{θJA}	Junction-to-Ambient ⑤	—	110	

* When mounted on 1" square PCB (FR-4 or G-10 Material) .
 For recommended footprint and soldering techniques refer to application note #AN-994

Notes ① through ⑤ are on page 9

Static @ T_J = 25°C (unless otherwise specified)

Symbol	Parameter	Min	Typ	Max	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	20	—	—	V	V _{GS} = 0V, I _D = 250μA
ΔV _{(BR)DSS/ΔT_J}	Breakdown Voltage Temp. Coefficient	—	0.021	—	V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance	—	7.3	9.5	mΩ	V _{GS} = 10V, I _D = 15A ③ V _{GS} = 4.5V, I _D = 12A ③
V _{GS(th)}	Gate Threshold Voltage	1.0	—	3.0	V	V _{DS} = V _{GS} , I _D = 250μA
I _{DSS}	Drain-to-Source Leakage Current	—	—	10	μA	V _{DS} = 20V, V _{GS} = 0V V _{DS} = 16V, V _{GS} = 0V, T _J = 125°C
I _{GSS}	Gate-to-Source Forward Leakage	—	—	200	nA	V _{GS} = 16V
	Gate-to-Source Reverse Leakage	—	—	-200	nA	V _{GS} = -16V

Dynamic @ T_J = 25°C (unless otherwise specified)

Symbol	Parameter	Min	Typ	Max	Units	Conditions
g _{fs}	Forward Transconductance	42	—	—	S	V _{DS} = 25V, I _D = 57A
Q _g	Total Gate Charge	—	19	—	nC	I _D = 28.4A V _{DS} = 10V V _{GS} = 4.5V ③
Q _{gs}	Gate-to-Source Charge	—	8.1	—		
Q _{gd}	Gate-to-Drain ("Miller") Charge	—	6.4	—		
Q _{OSS}	Output Gate Charge	—	16	24		
R _G	Gate Resistance	0.3	—	3.2	Ω	
t _{d(on)}	Turn-On Delay Time	—	8.4	—	ns	V _{DD} = 10V I _D = 28.4A R _G = 1.8Ω V _{GS} = 4.5V ③
t _r	Rise Time	—	98	—		
t _{d(off)}	Turn-Off Delay Time	—	12	—		
t _f	Fall Time	—	5.0	—		
C _{iss}	Input Capacitance	—	1996	—	pF	V _{GS} = 0V V _{DS} = 10V f = 1.0MHz
C _{OSS}	Output Capacitance	—	1085	—		
C _{rss}	Reverse Transfer Capacitance	—	155	—		

Avalanche Characteristics

Symbol	Parameter	Typ	Max	Units
E _{AS}	Single Pulse Avalanche Energy ^②	—	216	mJ
I _{AR}	Avalanche Current ^①	—	71	A

Diode Characteristics

Symbol	Parameter	Min	Typ	Max	Units	Conditions
I _S	Continuous Source Current (Body Diode)	—	—	75 ^④	A	MOSFET symbol showing the integral reverse p-n junction diode.
I _{SM}	Pulsed Source Current (Body Diode) ^①	—	—	300		
V _{SD}	Diode Forward Voltage	—	0.88	1.3	V	T _J = 25°C, I _S = 35.5A, V _{GS} = 0V ③ T _J = 125°C, I _S = 35.5A, V _{GS} = 0V ③
t _{rr}	Reverse Recovery Time	—	38	57	ns	T _J = 25°C, I _F = 35.5A, V _R = 20V
Q _{rr}	Reverse Recovery Charge	—	45	68	nC	di/dt = 100A/μs ③
t _{rr}	Reverse Recovery Time	—	41	62	ns	T _J = 125°C, I _F = 35.5A, V _R = 20V
Q _{rr}	Reverse Recovery Charge	—	50	75	nC	di/dt = 100A/μs ③

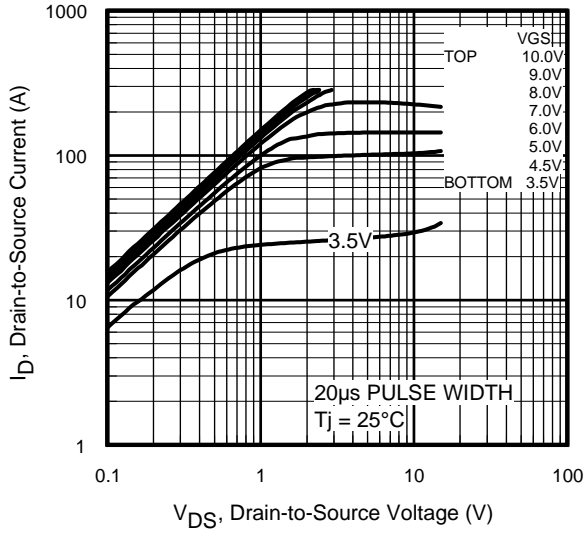


Fig 1. Typical Output Characteristics

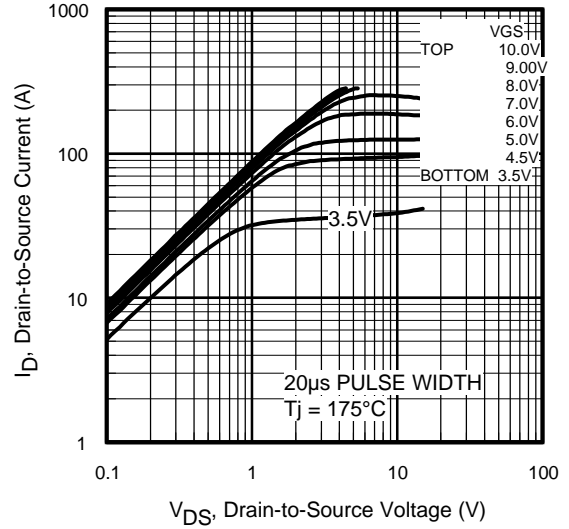


Fig 2. Typical Output Characteristics

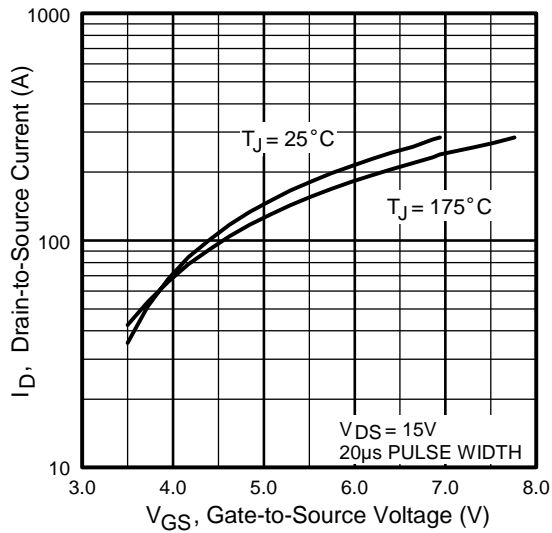


Fig 3. Typical Transfer Characteristics

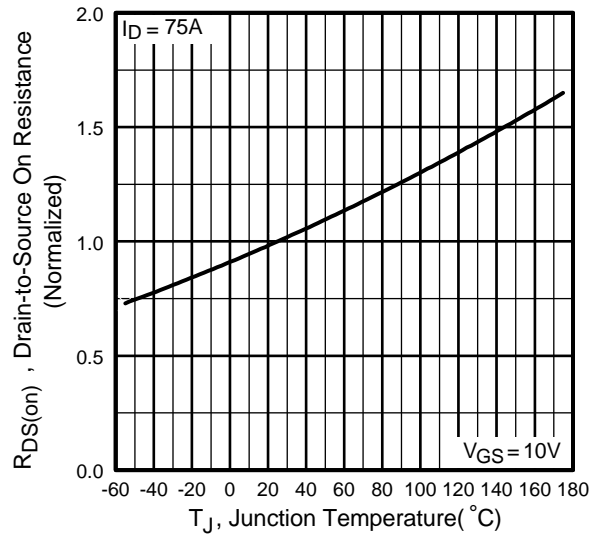


Fig 4. Normalized On-Resistance Vs. Temperature

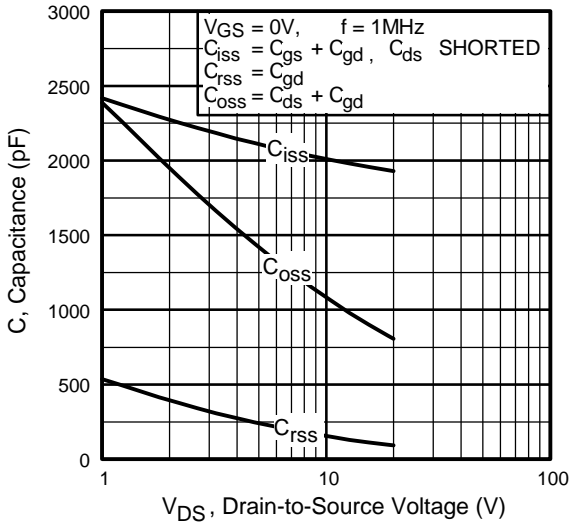


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

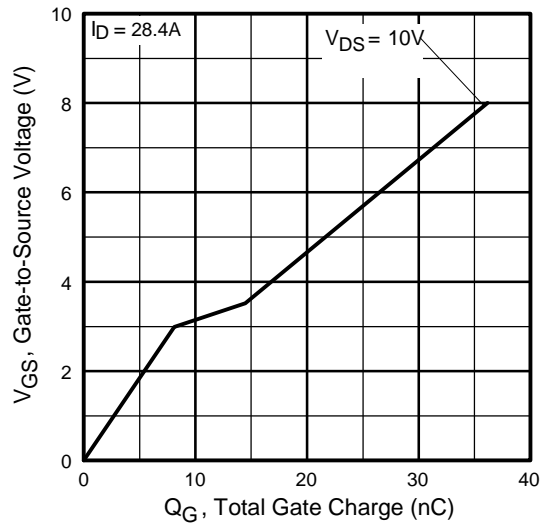


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

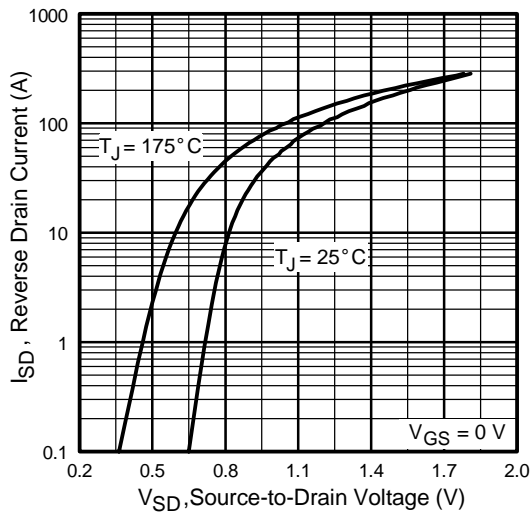


Fig 7. Typical Source-Drain Diode Forward Voltage

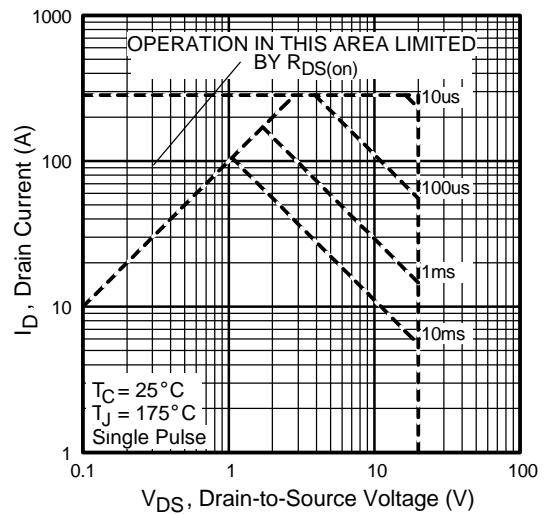


Fig 8. Maximum Safe Operating Area

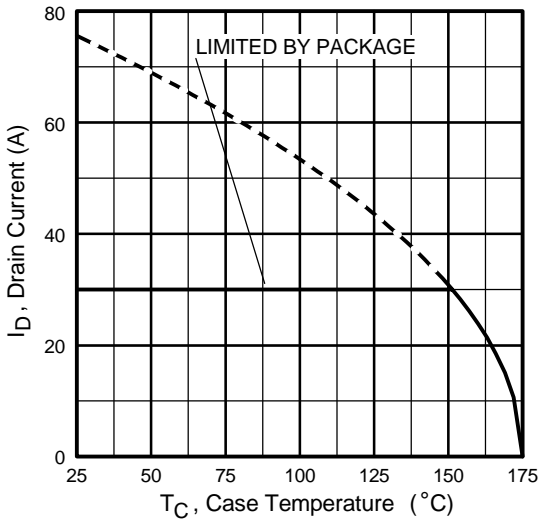


Fig 9. Maximum Drain Current Vs. Case Temperature

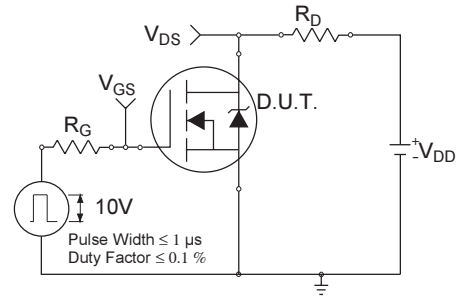


Fig 10a. Switching Time Test Circuit

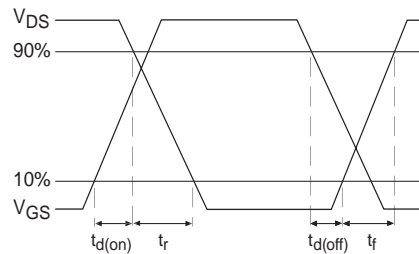


Fig 10b. Switching Time Waveforms

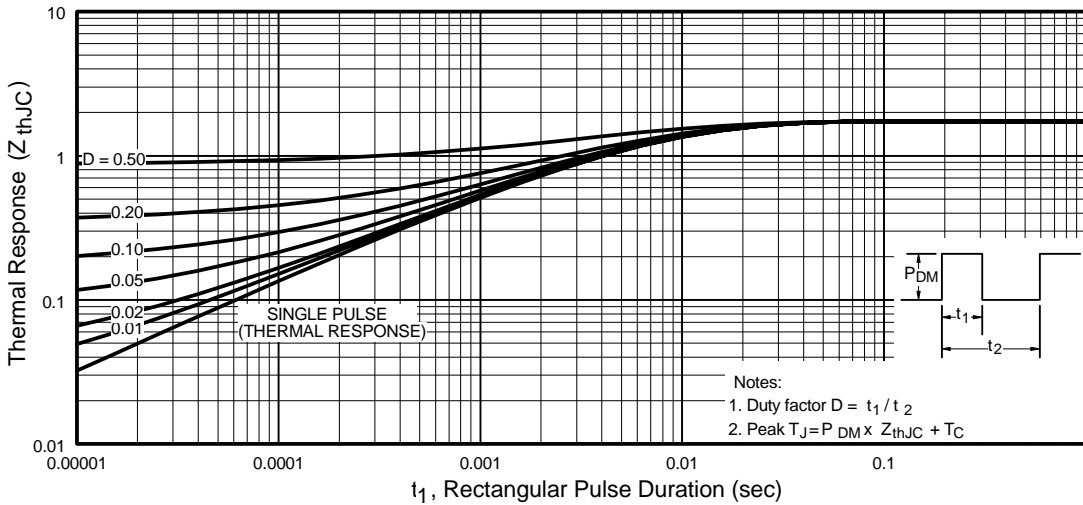


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

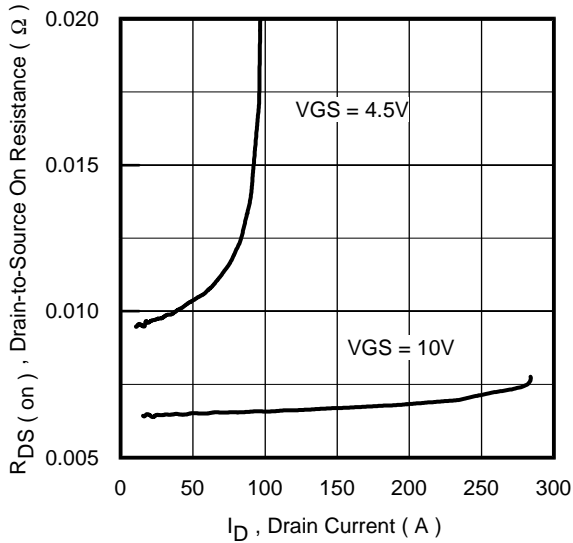


Fig 12. On-Resistance Vs. Drain Current

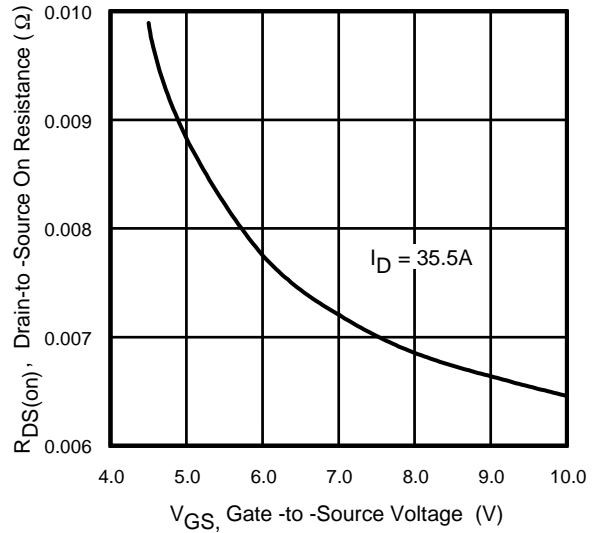


Fig 13. On-Resistance Vs. Gate Voltage

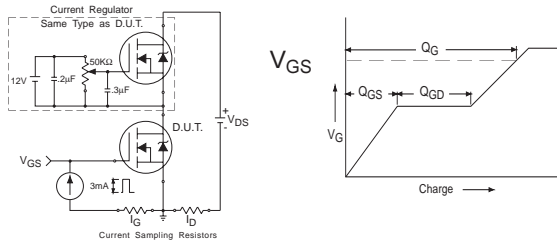


Fig 14a&b. Basic Gate Charge Test Circuit and Waveforms

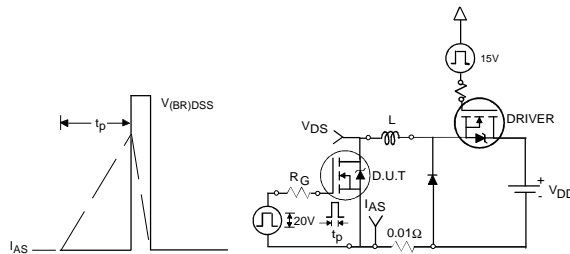


Fig 15a&b. Unclamped Inductive Test Circuit and Waveforms

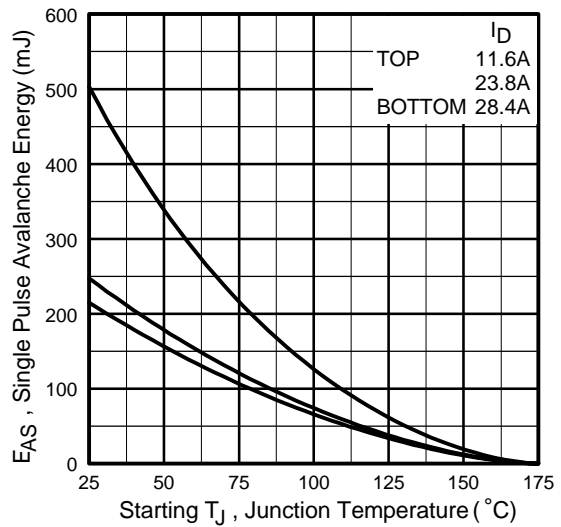
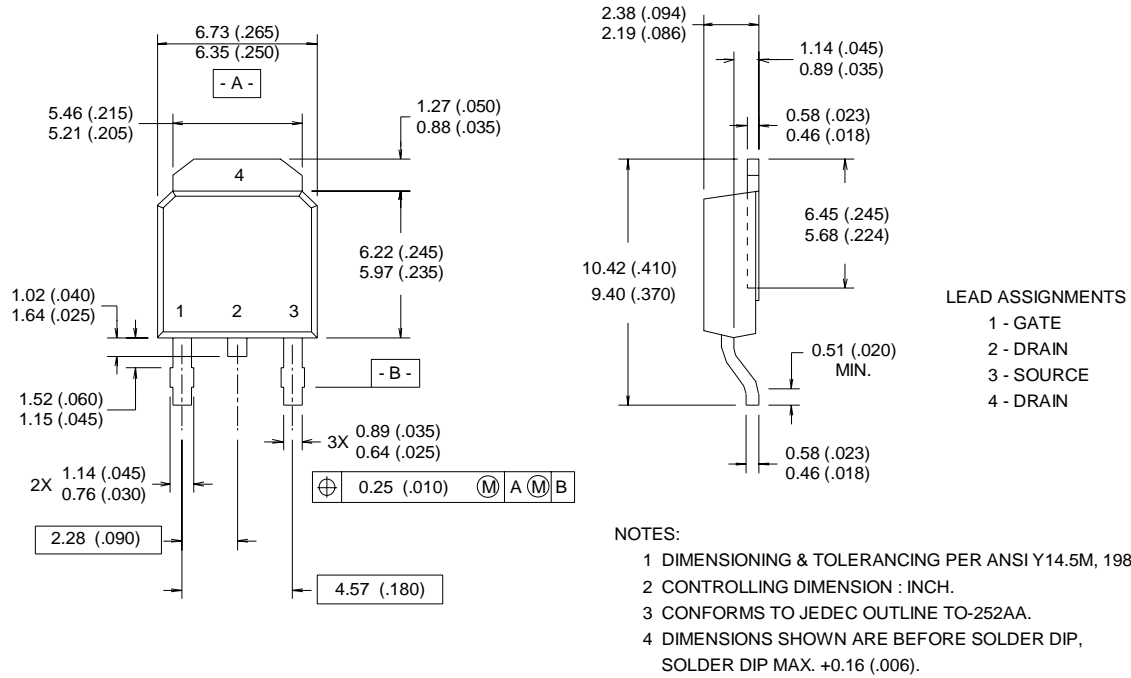


Fig 15c. Maximum Avalanche Energy Vs. Drain Current

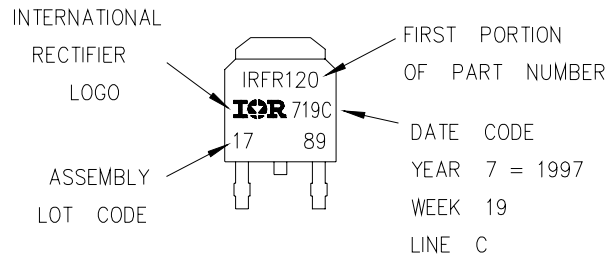
D-Pak (TO-252AA) Package Outline

Dimensions are shown in millimeters (inches)



D-Pak (TO-252AA) Part Marking Information

EXAMPLE: THIS IS AN IRFR120
 LOT CODE 1789
 ASSEMBLED ON WW 19, 1997
 IN THE ASSEMBLY LINE "C"

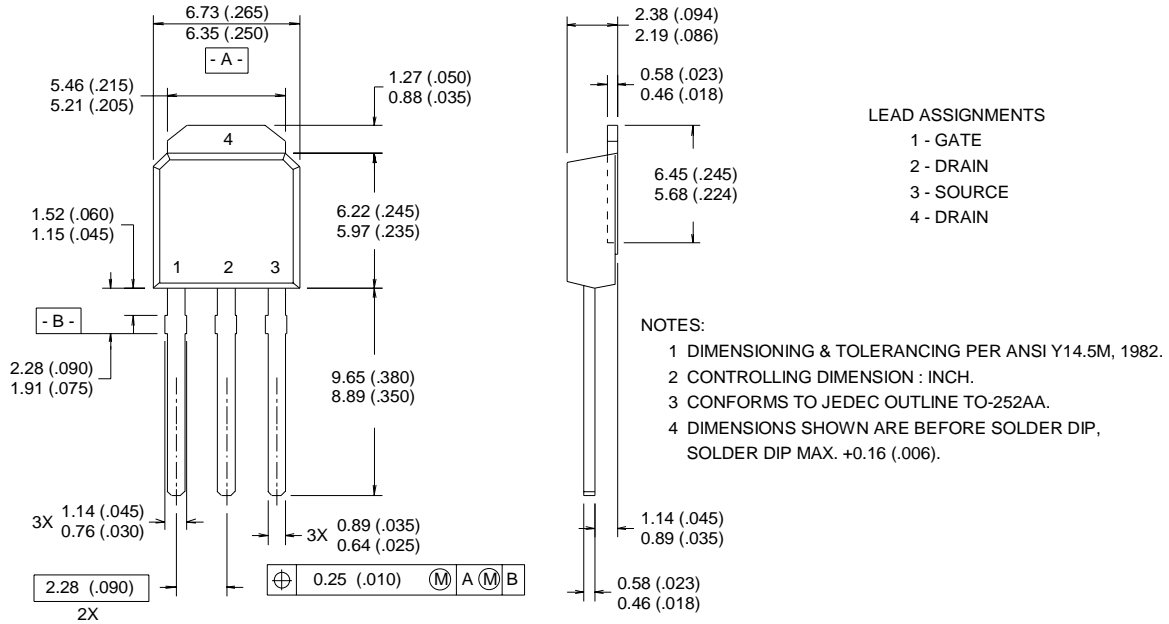


IRFR/U3704

International
IR Rectifier

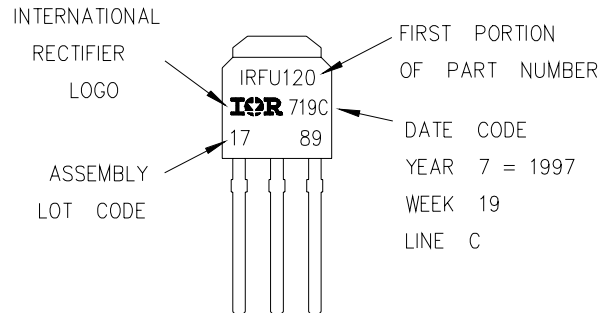
I-Pak (TO-251AA) Package Outline

Dimensions are shown in millimeters (inches)



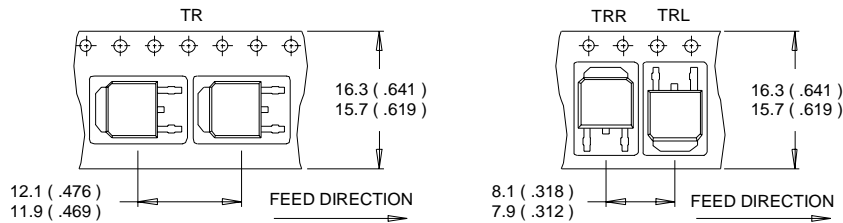
I-Pak (TO-251AA) Part Marking Information

EXAMPLE: THIS IS AN IRFU120
LOT CODE 1789
ASSEMBLED ON WW 19, 1997
IN THE ASSEMBLY LINE "C"

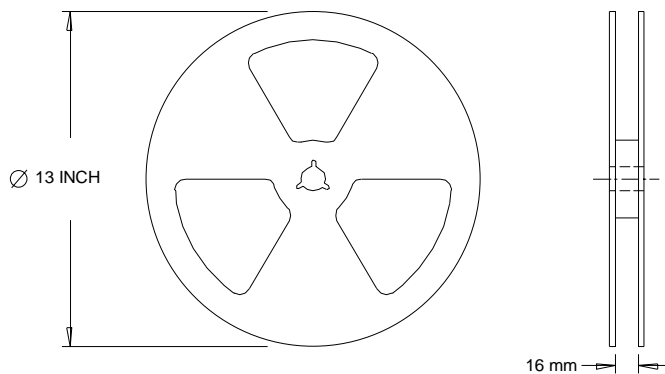


D-Pak (TO-252AA) Tape & Reel Information

Dimensions are shown in millimeters (inches)



- NOTES :
1. CONTROLLING DIMENSION : MILLIMETER.
 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



- NOTES :
1. OUTLINE CONFORMS TO EIA-481.

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting $T_J = 25^\circ\text{C}$, $L = 0.5 \text{ mH}$
 $R_G = 25\Omega$, $I_{AS} = 28.4 \text{ A}$.
- ③ Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.
- ④ Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 30A
- ⑤ R_θ is measured at T_J approximately 90°C

Data and specifications subject to change without notice.
 This product has been designed and qualified for the Industrial market.
 Qualification Standards can be found on IR's Web site.



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